

Aspiring research student focused on advancing the field of 3D User Interfaces. Leveraging experience in airborne ultrasound for creating tactile surfaces. Skilled in Unity(C#), Python, and VR development, aiming to contribute to systems that integrate seamlessly into daily life without cumbersome devices.

## Awards and Fellowships

2023.04 - 2025.03	<b>Research Fellowship for Young Scientists DC2</b> [Acceptance rate: 18.5 %] Japan Society for the Promotion of Science
2022.05	<b>3rd place in Demo Award, Eurohaptics2022</b> [International] Airborne Bumpy Surfaces Presented by Ultrasound
2021.12	<b>Presentation Award, SICE SI 2021</b> [Domestic] Curved Surface Presentation using Airborne Ultrasound
2020.09 - Current	<b>International Graduate Program of Innovation for Intelligent World</b> [Acceptance rate: 48.1 %] The University of Tokyo

## Selected Publications and Presentations

### Research Article

2021.04	<b>Fabrication of Eutectic Ga-In Nanowire Arrays Based on Plateau-Rayleigh Instability</b> Takashi Ikuno, <u>Zen Somei</u> , MOLECULES, 26(15), 4616.
2025.07	<b>Spatial Resolution of Mesoscopic Pattern via Contact Position Control using Airborne Ultrasound</b> <u>Zen Somei</u> , Tao Morisaki, Shun Suzuki, Yasutoshi Makino, Hiroyuki Shinoda, Transactions on Haptics [Under Review]

### Conference Proceedings (Oral Presentation)

2022.05	<b>Spatial Resolution of Mesoscopic Shapes</b> [Acceptance rate: 57.0 %] <u>Zen Somei</u> , Tao Morisaki, Yutaro Toide, Masahio Fujiwara, Yasutoshi Makino, Hiroyuki Shinoda, Eurohaptics 2022.
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## Education and Internships

2022.04 - In Progress	<b>Ph.D. in Complexity Science and Engineering</b> The University of Tokyo
2022.10 - 2022.12	<b>Internship at UCL, UK</b> Theme: Impact-based Ultrasound Haptics
2022.10 - 2022.12	<b>Internship at NEC, Japan</b> Theme: Dynamic Prediction
2020.04 - 2022.03	<b>M.S. in Complexity Science and Engineering</b> The University of Tokyo
2016.04 - 2020.03	<b>B.S. in Applied Electronics</b> Tokyo University of Science

## Contact

### E-mail

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### LinkedIn

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## Skills

C, C++, C#, Unity, Python, VR Development, Hand Sensing, HCI, Ultrasound Manipulation.

## Languages

Japanese, English, Chinese.

## Interests

Haptics, VR, AR, Metaverse, Engineering, HCI, Ultrasound Technology, 3D User Interfaces.